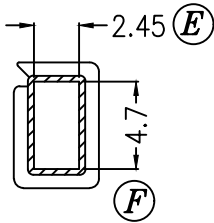
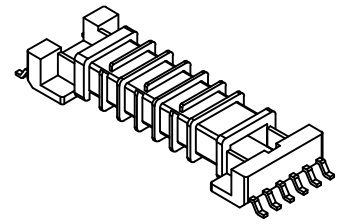
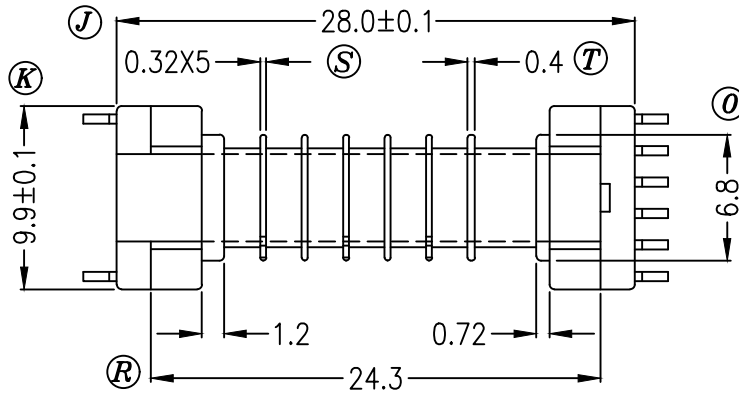
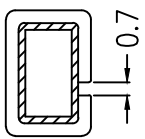
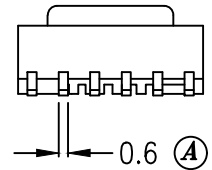
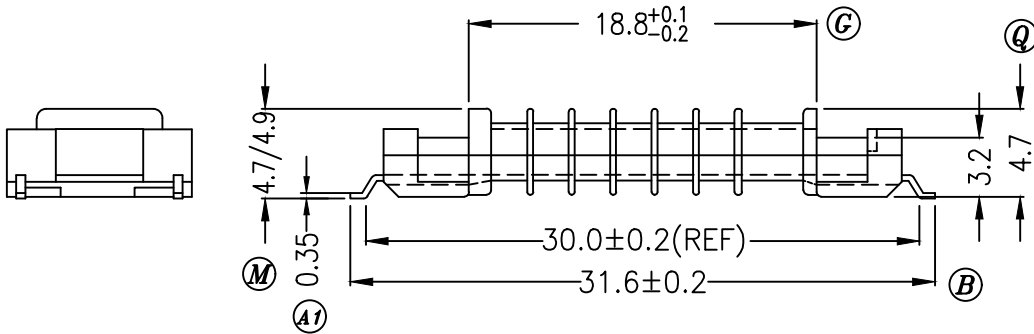


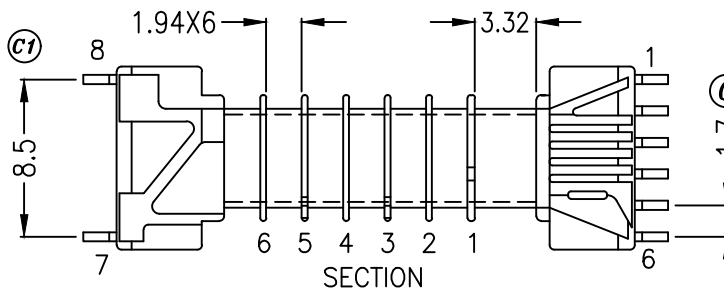
SECTION 3-5



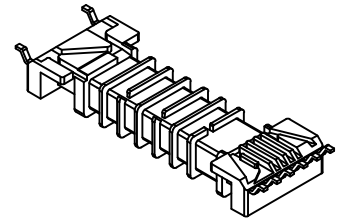
SECTION 2-4-6



SECTION 1



SECTION



B-084.701L

REV.	REVISIONS REC.	DATE	REV.	REVISIONS REC.	DATE
1	(G) 改變公差 18.8±0.3 → 18.8 ^{+0.1} / _{-0.2}	2009.04.21			

DRAWN & DRAFTED BY 陳孝忠	TOLERANCES		ANGLE: ±1°	TITLE: SMD BOBBIN FRAME-10	
	0<L≤4 ±0.1	PIN PITCH ±0.2	UNIT: MM	BOBBIN MATERIAL: LCP E4008	UL REC. UL 94V-0
CHECKED & APPROVED BY	4<L≤16 ±0.2		ORIGIN: DG	PIN MATERIAL: PHOSPHOR BRONZE	PIN TENSION LOAD: 1.0KG MIN
PIN SHINE INDUSTRIAL CO.,LTD.			DATE: JUL.30 '2002	DRAWING NO. S-1007	REV. 1
TEL:886-2-22990545 FAX:886-2-22990546					